

### CoreSDR v4.3 Release Notes

This document accompanies the production release of CoreSDR v4.3 IP core. It describes the features and enhancements. It also contains the information on system requirements, supported families, implementations, known limitations and workarounds, and resolved issues of previous version.

#### **Features**

CoreSDR is a highly configurable core and has the following features:

- High performance, single data rate controller for standard SDRAM chips and DIMMs
- · Synchronous interface, fully pipelined internal architecture
- Supports up to 1,024 MB of memory
- Bank management logic monitors status of up to 8 SDRAM banks

## **Delivery Types**

The CoreSDR is licensed as register transfer level (RTL). Complete RTL source code is provided for the core and testbenches.

# **Supported Families**

- Axcelerator<sup>®</sup>
- RTAX<sup>™</sup>-S
- ProASIC®3
- ProASIC®3E
- ProASIC®3L
- ProASICPLUS®
- Fusion<sup>®</sup>
- SmartFusion®
- SmartFusion®2
- IGLOO<sup>®</sup>
- IGLOO®e
- IGLOO<sup>®</sup>2
- IGLOOPLUS®
- RTG4<sup>™</sup>
- PolarFire
- PolarFire SoC

## Supported Tool Flows

This version must be used with Libero<sup>®</sup> integrated design environment (IDE) v9.2 SP2 or later Libero System-on-Chip (SoC) v11.5 SP2 or later with this CoreSDR release.



### Installation Instructions

Within the Libero IDE or SoC software, click **Add Core** in the Catalog to locate and install a local CPZ file, or use the automatic web update feature in Libero IDE or SoC. Once the CPZ file is installed in the Libero IDE or SoC, the core can be instantiated, configured, and generated within SmartDesign for inclusion in your Libero IDE or SoC project. Refer the Libero online help for further instructions on core instantiation, licensing, and general use.

#### **Documentation**

For more information about Microsemi Intellectual Property, visit <a href="http://www.microsemi.com/products/fpga-soc/design-resources/ip-cores">http://www.microsemi.com/products/fpga-soc/design-resources/ip-cores</a>. For updates and additional information about Microsemi software, FPGAs, and hardware, visit <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

## Supported Test Environments

The following test environments are supported for CoreSDR:

- · Verilog user testbench
- VHDL user testbench
- · Verilog Verif testbench
- VHDL Verif testbench (Supported using Mixed Mode)

#### Discontinued Features and Devices

There are no discontinued features in the v4.3 release.

### **New Features and Devices**

Added VHDL Verif testbench for SDR 64Mx40 which instantiates a Micron 512 Mbit SDRAM model(16Meg x 8x 4 banks) with five instances and SDR 64Mx48 which instantiates a Micron 512 Mbit SDRAM model(16Meg x 8 x 4 banks) with six instances.

## Release History

Table 1 details the release history of this core.

Table 1 CoreSDR Release History

Version	Date	Changes	
4.3	May 2020	Added VHDL Verif testbench to support SDR 64MX40 and SDR64MX48, and SAR fixes.	
4.2	November 2019	Added Verilog Verif testbench to support SDR 64Mx40 and SDR64Mx48, and SAR fixes.	
4.1	June 2015	Added SmartFusion2, IGLOO2, RTG4, and SAR fixes	
4.0	March 2009	SAR fixes (refer to Table 4)	
		Delivery mechanism through SmartDesign	
3.0	May 2007	Delivery mechanism through CoreConsole	
2.0	January 2005	Initial version	

### Resolved Issues in the v4.3 Release

Table 2 lists the Software Action Requests (SARs) that were resolved in the CoreSDR v4.3 release.

Table 2 Resolved Issues in the v4.3 Release

SAR	Description		
111357	Added VHDL Verif Testbench support for CoreSDR 64Mx48 and 64Mx40 SDRAM.		
111823	Added SDR Initial values r_shift and m_shift in Syn/Asyn Reset as did in SD_INIT always block.		

### Resolved Issues in the v4.2 Release

Table 2 lists the Software Action Requests (SARs) that were resolved in the CoreSDR v4.2 release.

Table 3 Resolved Issues in the v4.2 Release

SAR	Description		
108235	Added support for CoreSDR 64Mx48 and 64Mx40 SDRAM.		
91017	Fixed RTL issue for max column address size 13 bits.		

#### Resolved Issues in the v4.1 Release

Table 3 lists the Software Action Requests (SARs) that were resolved in the CoreSDR v4.1 release.

Table 4 Resolved Issues in the v4.1 Release

SAR	Description
66863	Added support for RTG4 family devices.
44933	Core categorization incorrect/incomplete.
36152	Need to check that device family support for this core is correct.

## Resolved Issues in the v4.0 Release

Table 4 lists the Software Action Requests (SARs) that were resolved in the CoreSDR v4.0 release.

Table 5 Resolved Issues in the v4.0 Release

SAR	Description
11386, 11880, 11881, 13876	Some CoreSDR parameters are not configurable. Even though the parameters are defined at the top level, if we change some of the parameters, the design breaks, although it is in valid range. The design has been changed to support all ranges of the given parameters.
11404	Table 8 of the handbook shows standard SDR SDRAM device configurations. It is not clear to the user how to use this table. The handbook was updated with more detailed explanation.
11405	Updated the handbook on how to set the SDRAM controller parameters using an example
11707	Changed from \$finish to \$stop to specify simulation end-point in the verilog user testbench
11756	Updated the wave file with testbench signals
11833	Removed floating signals in the testbench
11834	Removed floating signals in the design
12111	Fixed the issue with load mode register in VHDL base code



# Known Issues and Workarounds

There are no known limitations or workarounds in the CoreSDR v4.3.



а **Міскоснір** company

Microsemi Headquarters
One Enterprise, Aliso Viejo, CA 92656 USA
Within the USA: +1 (800) 713-4113
Outside the USA: +1 (949) 380-6100
Sales: +1 (949) 380-6136
Fax: +1 (949) 215-4996

email: sales.support@microsemi.com www.microsemi.com

©2020 Microsemi, a wholly owned subsidiary of Microchip Technology Inc. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other trademarks and service marks are the property of their respective owners.

Microsemi, a wholly owned subsidiary of Microchip Technology Inc. (Nasdaq: MCHP), offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions, security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services

Learn more at www.microsemi.com.

Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document is proprietary to Microsemi. and Microsemi